

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT7560846

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	PATENT SECURITY AGREEMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ELECTRONIC CUSTOM DISTRIBUTORS, INC.	09/26/2022
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	JPMORGAN CHASE BANK, N.A., AS ADMINISTRATIVE AGENT
<b>Street Address:</b>	CIB DMO WLO, MAIL CODE NY1-C413, 4CMC
<b>City:</b>	BROOKLYN
<b>State/Country:</b>	NEW YORK
<b>Postal Code:</b>	11245
<b>PROPERTY NUMBERS Total: 8</b>	
<b>Property Type</b>	<b>Number</b>
Patent Number:	7249961
Patent Number:	8376171
Patent Number:	D573544
Patent Number:	D600644
Patent Number:	8490815
Patent Number:	D774628
Patent Number:	D905830
Patent Number:	D905831
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	2023704750
<b>Email:</b>	ipteam@cogencyglobal.com
<b>Correspondent Name:</b>	JOANNA MCCALL
<b>Address Line 1:</b>	1025 CONNECTICUT AVE NW, SUITE 712
<b>Address Line 2:</b>	COGENCY GLOBAL INC.
<b>Address Line 4:</b>	WASHINGTON, D.C. 20036
<b>ATTORNEY DOCKET NUMBER:</b>	1792844
<b>NAME OF SUBMITTER:</b>	SONYA JACKMAN
<b>SIGNATURE:</b>	/Sonya Jackman/

PATENT

<b>DATE SIGNED:</b>	09/27/2022
<b>Total Attachments: 4</b> source=#96160007v1 - (Resideo - ECD - Patent Security Agreement)#page2.tif source=#96160007v1 - (Resideo - ECD - Patent Security Agreement)#page3.tif source=#96160007v1 - (Resideo - ECD - Patent Security Agreement)#page4.tif source=#96160007v1 - (Resideo - ECD - Patent Security Agreement)#page5.tif	

PATENT SECURITY AGREEMENT dated as September 26, 2022 (this "Agreement"), between ELECTRONIC CUSTOM DISTRIBUTORS, INC. (the "Grantor") and JPMorgan Chase Bank, N.A. ("JPMCB"), as Administrative Agent.

Reference is made to (a) the Amended and Restated Credit Agreement dated as of February 12, 2021 (as amended by the First Amendment to Amended and Restated Credit Agreement, dated as of March 28, 2022, and as further amended, restated, amended and restated, supplemented or otherwise modified from time to time, the "Amended Credit Agreement"), among Holdings, U.S. HoldCo 1, U.S. HoldCo 2, the Borrower, the Lenders and Issuing Banks from time to time party thereto and JPMCB, as Administrative Agent, and (b) the Amended and Restated Collateral Agreement, dated as of February 12, 2021 (as amended, restated, amended and restated, supplemented or otherwise modified from time to time, the "Amended Collateral Agreement"), among Holdings, U.S. HoldCo 1, U.S. HoldCo 2, the Borrower, the Subsidiary Loan Parties from time to time party thereto and JPMCB, as Administrative Agent. The parties hereto agree as follows:

SECTION 1. Terms. Each capitalized term used but not otherwise defined herein shall have the meaning specified in the Amended Credit Agreement or the Amended Collateral Agreement, as applicable. The rules of construction specified in Section 1.03 of the Amended Credit Agreement also apply to this Agreement, mutatis mutandis.

SECTION 2. Grant of Security Interest. As security for the payment or performance, as the case may be, in full of the Secured Obligations, the Grantor, pursuant to the Amended Collateral Agreement, did and hereby does grant to the Administrative Agent and its successors and assigns, for the benefit of the Secured Parties, a security interest in all of the Grantor's right, title and interest in, to and under the portion of the Article 9 Collateral constituting the Patents listed on Schedule I hereto, subject to the exclusions set forth in Section 4.01(d) of the Amended Collateral Agreement (collectively, the "Patent Collateral").

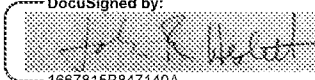
SECTION 3. Amended Collateral Agreement. This Agreement has been executed and delivered by the Grantor for the purpose of recording the grant of security interest herein with the United States Patent and Trademark Office. The security interest granted hereby has been granted to the Administrative Agent for the benefit of the Lenders in connection with the Amended Collateral Agreement and is expressly subject to the terms and conditions thereof. The Grantor hereby acknowledges and affirms that the rights and remedies of the Administrative Agent with respect to the Patent Collateral are more fully set forth in the Amended Collateral Agreement, the terms and provisions of which are hereby incorporated herein by reference as if fully set forth herein. In the event of any conflict between the terms of this Agreement and the Amended Collateral Agreement, the terms of the Amended Collateral Agreement shall govern.

SECTION 4. Counterparts. This Agreement may be executed in counterparts (and by different parties hereto on different counterparts), each of which shall constitute an original, but all of which when taken together shall constitute a single contract. Delivery of an executed counterpart of a signature page of this Agreement by facsimile or other electronic imaging shall be effective as delivery of a manually executed counterpart of this Agreement.

SECTION 5. CHOICE OF LAW. THIS AGREEMENT AND ANY CLAIM, CONTROVERSY, DISPUTE OR CAUSE OF ACTION (WHETHER IN CONTRACT OR TORT OR OTHERWISE) BASED UPON, ARISING OUT OF OR RELATING TO THIS AGREEMENT SHALL BE GOVERNED BY, AND CONSTRUED IN ACCORDANCE WITH, THE LAW OF THE STATE OF NEW YORK.

IN WITNESS WHEREOF, the parties hereto have duly executed this Agreement as of the day and year first above written.

ELECTRONIC CUSTOM DISTRIBUTORS, INC.,  
as Grantor

By:   
Name: John Heskett  
Title: Treasurer

[SIGNATURE PAGE TO PATENT SECURITY AGREEMENT]

**PATENT**  
**REEL: 061552 FRAME: 0419**

JPMORGAN CHASE BANK, N.A.,  
as Administrative Agent

By   
Name: Gene Riego de Dios  
Title: Executive Director

[SIGNATURE PAGE TO PATENT SECURITY AGREEMENT]

**PATENT**  
**REEL: 061552 FRAME: 0420**

## SCHEDULE I

### Patents

	Patent No.	Title	Issue Date	Owner
1	7249961	Jack Assembly and Method of Performing Electrical Coupling	Jul. 31, 2007	ELECTRONIC CUSTOM DISTRIBUTORS, INC.
2	8376171	Method and System of a Detachable Nose Faceplate	Feb. 19, 2013	ELECTRONIC CUSTOM DISTRIBUTORS, INC.
3	D573544	Multi-Control VGA Face Plate	Jul. 22, 2008	ELECTRONIC CUSTOM DISTRIBUTORS, INC.
4	D600644	High Definition Multimedia Interface Pigtail	Sep. 22, 2009	ELECTRONIC CUSTOM DISTRIBUTORS, INC.
5	8490815	Method and System of a Reversible Nose Faceplate	Jul. 23, 2013	ELECTRONIC CUSTOM DISTRIBUTORS, INC.
6	D774628	Conduit Coupler	Dec. 20, 2016	ELECTRONIC CUSTOM DISTRIBUTORS, INC.
7	D905830	Conduit Coupler	Dec. 22, 2020	ELECTRONIC CUSTOM DISTRIBUTORS, INC.
8	D905831	Conduit Coupler	Dec. 22, 2020	ELECTRONIC CUSTOM DISTRIBUTORS, INC.

### Patent Applications

None.